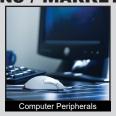


APPLICATIONS / MARKETS













RoHS

SPECIFICATIONS

Electrical Rating: 50mA, 12VDC

Contact Resistance: $500m\Omega$ Max. (Initial) Insulation Resistance: $100M\Omega$ Min. at 500VDC Dielectric Strength: 250VAC for 1 Minute

Life Cycles: 100,000 cycles

Contact Material: Silver

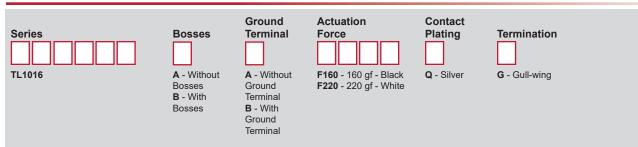
Operating Temperature: -40°C to 85°C Storage Temperature: -40°C to 85°C Travel: 0.20mm +0.2/-0.1mm Operating Force: 160gf, 220gf Function: SPST, Off-(On) Bounce: 10msec Max.

Packaging: Tape and Reel, 3,500 pcs/reel

FEATURES & BENEFITS

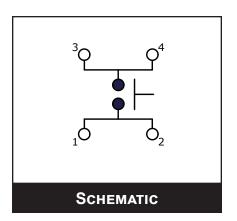
- · Right angle Surface mount design
- 3.5 x 3.55mm size
- Up to 100,000 cycle life expectancy
- · Multiple actuation force options
- · Mounting boss option
- · Ground terminal option
- Tape and Reel packaging

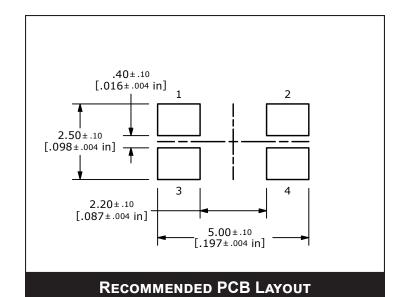
PART NUMBER CONFIGURATOR

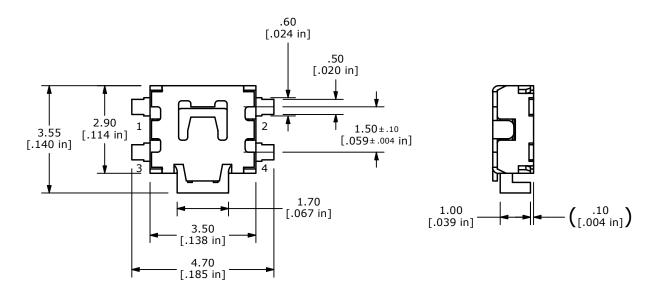


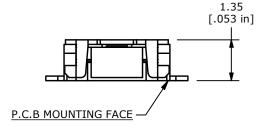
Specifications subject to change without notice 12.7.2022

BODY DIMENSIONS WITHOUT BOSSES AND **GROUND TERMINAL**

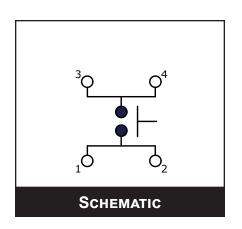


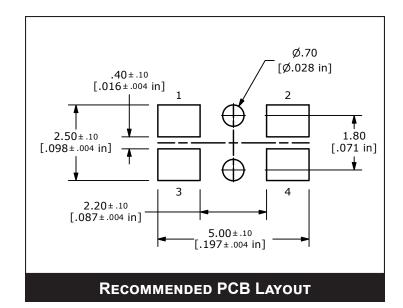


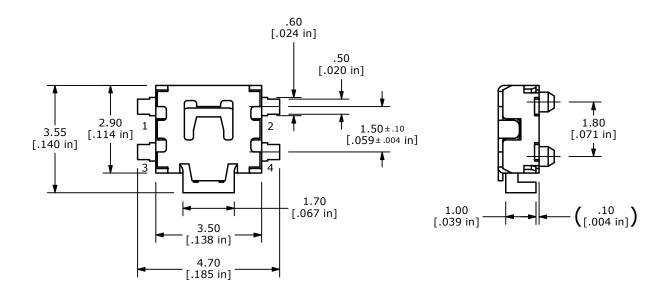


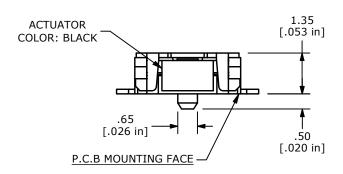


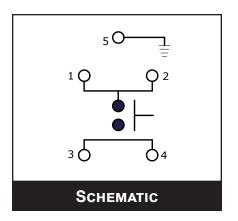
BODY DIMENSIONS WITH BOSSES AND WITHOUT GROUND TERMINAL

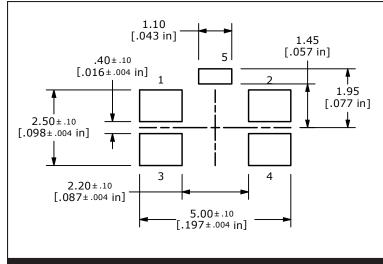




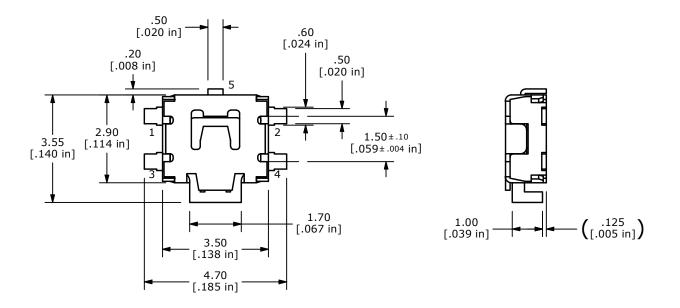


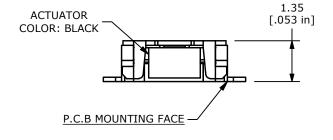




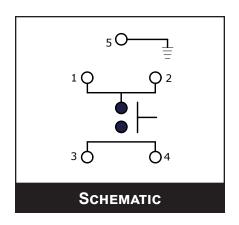


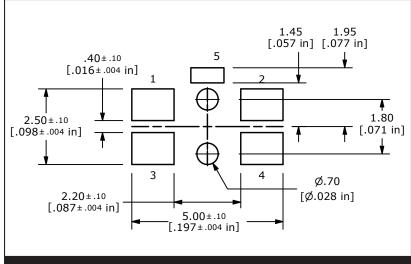
RECOMMENDED PCB LAYOUT



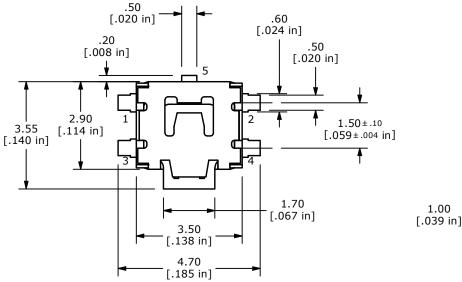


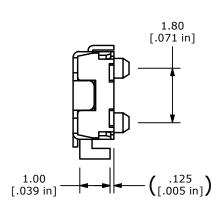
BODY DIMENSIONS WITH BOSSES AND **GROUND TERMINAL**

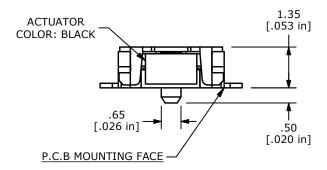


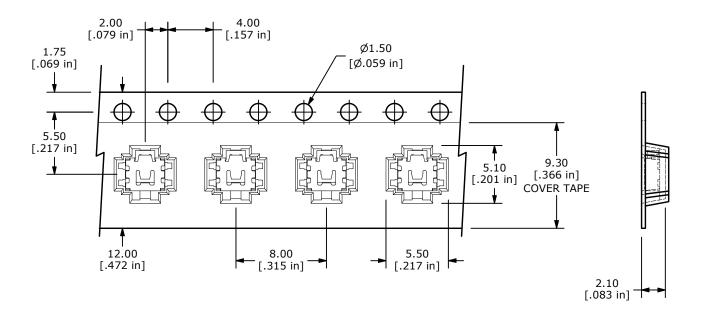


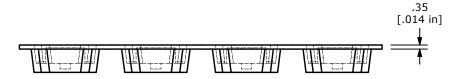
RECOMMENDED PCB LAYOUT

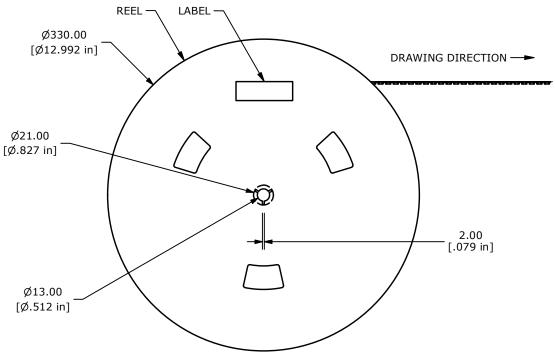












RECOMMENDED SOLDER PROCESS

Most contamination problems can be prevented by exercising care during the cleaning and soldering process. Care should be taken not to immerse or spray unsealed switches during flux removal. Contact E-Switch for specific soldering recommendations and specifications not shown. Generalized soldering procedures are outlined below.

"TYPICAL" SMT REFLOW (Pb and Pb-Free)

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-Up Rate		
(Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat		
-Temperature Min (Ts _{min})	100 °C	150 °C
-Temperature Max (Ts _{max})	150 °C	200 °C
-Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained above:		
-Temperature (T _L)	183 °C	217 °C
-Time (t _L)	60-150 seconds	60-150 seconds
Time within 5 °C of actual	10-30 seconds	20-40 seconds
Peak Temperature (tp)		
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak		
Temperature	6 minutes max.	8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package surface.

